



In re application of: Chen et al
 Serial No.: 10/053,785
 Filed: 01/18/02
 For: 'Method For Electroplating A Body-Centered Cubic Nickel-Iron Alloy Thin Film With A High Saturation Flux Density'

COMMISSIONER FOR PATENTS
 ALEXANDRIA, VA 22313-1450

SIR:

Transmitted herewith for the above-identified application are:

- ☒ Response to Office Action
☒ Declaration and Power of Attorney for Patent Application
☒ Statement of Added Inventor (37 CFR § 1.48(a)(1))
☒ Written Consent of Assignee
☐ No additional fee is required

The fee has been calculated as shown below:

CLAIMS REMAINING AFTER AMENDMENT	HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDIT. FEE
TOTAL 14 MINUS 14 = 0			x 50 =	\$.00
INDEP. 1 MINUS 1 = 0			x 200 =	\$.00
FIRST PRESENTATION OF MULTIPLE DEP. CLAIM			+ 360 =	\$
			Surcharge	\$
			TOTAL	\$.00

☐ Please charge my Deposit Account No. 50-2587 in the amount of \$ 0.00.
 A duplicate copy of this sheet is attached.

☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account 50-2587. A duplicate copy of this sheet is attached.

- ☐ Any filing fees under 37 CFR 1.16 for the presentation of extra claims.
☒ Any patent application processing fees under 37 CFR 1.17.

CERTIFICATE OF MAILING

I hereby certify that the above paper/fee is being deposited with the United States Postal Service as first class mail in an envelope addressed to the Commissioner for Patents, Alexandria, VA 22313-1450 on

January 14, 2005

Person Mailing paper/fee

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Signature

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